

2.5V SINGLE DATA RATE 1:10 CLOCK BUFFER TERABUFFER™

FEATURES:

- Guaranteed Low Skew < 25ps (max)
- Very low duty cycle distortion
- High speed propagation delay < 2.5ns. (max)
- Up to 250MHz operation
- Very low CMOS power levels
- 1.5V VDDQ for HSTL interface
- · Hot insertable and over-voltage tolerant inputs
- · 3-level inputs for selectable interface
- Selectable HSTL, eHSTL, 1.8V / 2.5V LVTTL, or LVEPECL input interface
- Selectable differential or single-ended inputs and ten singleended outputs
- 2.5V VDD
- · Available in TSSOP package

APPLICATIONS:

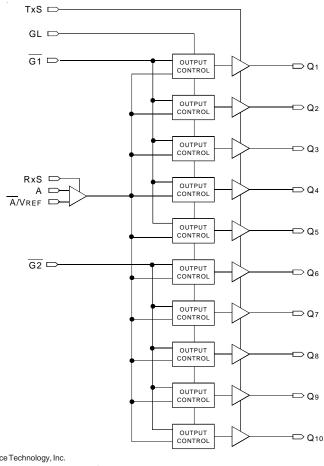
Clock and signal distribution

FUNCTIONAL BLOCK DIAGRAM

DESCRIPTION:

The IDT5T9072.5V single data rate (SDR) clock buffer is a user-selectable single-ended or differential input to ten single-ended outputs buffer built on advanced metal CMOS technology. The SDR clock buffer fanout from a single or differential input to ten single-ended outputs reduces the loading on the preceding driver and provides an efficient clock distribution network. The IDT5T907 can act as a translator from a differential HSTL, eHSTL, 1.8V/2.5V LVTTL, LVEPECL, or single-ended 1.8V/2.5V LVTTL input to HSTL, eHSTL, 1.8V/2.5V LVTTL outputs. Selectable interface is controlled by 3-level input signals that may be hard-wired to appropriate high-mid-low levels.

The IDT5T907 has two output banks that can be asynchronously enabled/ disabled. Multiple power and grounds reduce noise.

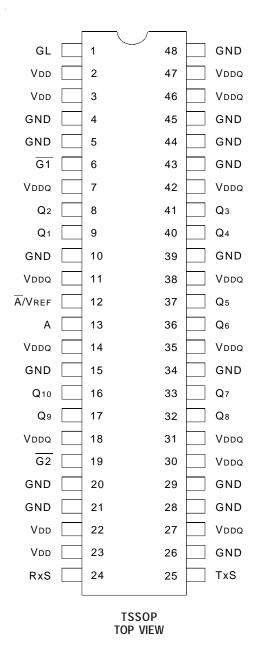


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FEBRUARY 2003

INDUSTRIAL TEMPERATURE RANGE

PINCONFIGURATION



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
Vdd	Power Supply Voltage ⁽²⁾	-0.5 to +3.6	V
VDDQ	Output Power Supply ⁽²⁾	-0.5 to +3.6	V
Vi	Input Voltage -0.		V
Vo	Output Voltage ⁽³⁾	-0.5 to VDDQ +0.5	V
Vref	Reference Voltage ⁽³⁾	-0.5 to +3.6	V
Tstg	Storage Temperature	-65 to +165	°C
TJ	Junction Temperature	150	°C

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

VDDQ and VDD internally operate independently. No power sequencing requirements need to be met.

3. Not to exceed 3.6V.

CAPACITANCE⁽¹⁾ (TA = +25°C, F = 1.0MHz)

Symbol	Parameter	Min	Тур.	Max.	Unit
Cin	Input Capacitance	1	3.5	_	pF

NOTE:

1. This parameter is measured at characterization but not tested. Capacitance applies to all inputs except RxS and TxS.

RECOMMENDED OPERATING RANGE

Symbol	Description	Min.	Тур.	Max.	Unit
TA	Ambient Operating Temperature	-40	+25	+85	°C
VDD ⁽¹⁾	Internal Power Supply Voltage	2.4	2.5	2.6	V
	HSTL Output Power Supply Voltage	1.4	1.5	1.6	V
VDDQ ⁽¹⁾	Extended HSTL and 1.8V LVTTL Output Power Supply Voltage	1.65	1.8	1.95	V
	2.5V LVTTL Output Power Supply Voltage		Vdd		V
VT	Termination Voltage		Vddq/2		V

NOTE:

1. All power supplies should operate in tandem; if Vod or Vodo is at a maximum, then Vodo or Vod (respectively) should be at a maximum, and vice-versa.

PINDESCRIPTION

Symbol	I/O	Туре	Description						
Α	Ι	Adjustable ⁽¹⁾	Clock input. A is the "true" side of the differential clock input. If operating in single-ended mode, A is the clock input.						
Ā/Vref	I	Adjustable ⁽¹⁾	plementary clock input. Ā/VREF is the "complementary" side of A if the input is in differential mode. If operating in single-ended e, Ā/VREF is connected to GND. For single-ended operation in differential mode, Ā/VREF should be set to the desired toggle ge for A:						
			2.5VLVTTL VREF = 1250mV						
			1.8V LVTTL, eHSTL VREF = 900mV						
			HSTL VREF = 750mV						
			LVEPECL VREF = 1082mV						
G1	I	LVTTL ⁽⁵⁾	Gate for outputs Q1 through Q5. When $\overline{G1}$ is LOW, these outputs are enabled. When $\overline{G1}$ is HIGH, these outputs are asynchronously disabled to the level designated by $GL^{(4)}$.						
G2	I	LVTTL ⁽⁵⁾	Gate for outputs Q ₆ through Q ₁₀ . When $\overline{G2}$ is LOW, these outputs are enabled. When $\overline{G2}$ is HIGH, these outputs are asynchronously disabled to the level designated by GL ⁽⁴⁾ .						
GL	I	LVTTL ⁽⁵⁾	Specifies output disable level. If HIGH, the outputs disable HIGH. If LOW, the outputs disable LOW.						
Qn	0	Adjustable ⁽²⁾	Clock outputs						
RxS	I	3 Level ⁽³⁾	Selects single-ended 2.5V LVTTL (HIGH), 1.8V LVTTL (MID) clock input or differential (LOW) clock input						
TxS	I	3 Level ⁽³⁾	Sets the drive strength of the output drivers to be 2.5V LVTTL (HIGH), 1.8V LVTTL (MID) or HSTL (LOW) compatible. Used in conjunction with VDDQ to set the interface levels.						
Vdd		PWR	Power supply for the device core and inputs						
Vddq		PWR	Power supply for the device outputs. When utilizing 2.5V LVTTL outputs, V_{DDQ} should be connected to V_{DD} .						
GND		PWR	Power supply return for all power						

NOTES:

1. Inputs are capable of translating the following interface standards. User can select between:

Single-ended 2.5V LVTTL levels Single-ended 1.8V LVTTL levels or Differential 2.5V/1.8V LVTTL levels Differential HSTL and eHSTL levels

Differential LVEPECL levels

2. Outputs are user selectable to drive 2.5V, 1.8V LVTTL, eHSTL, or HSTL interface levels when used with the appropriate VDDQ voltage.

3. 3 level inputs are static inputs and must be tied to Vob or GND or left floating. These inputs are not hot-insertable or over-voltage tolerant.

4. Because the gate controls are asynchronous, runt pulses are possible. It is the user's responsibility to either time the gate control signals to minimize the possibility of runt pulses or be able to tolerate them in down stream circuitry.

5. Pins listed as LVTTL inputs will accept 2.5V signals when RxS = HIGH or 1.8V signals when RxS = LOW or MID.

INPUT/OUTPUT SELECTION⁽¹⁾

Input	Output	Input	Output
2.5V LVTTL SE	2.5VLVTTL	2.5V LVTTL SE	eHSTL
1.8V LVTTL SE	1 [1.8V LVTTL SE	
2.5V LVTTL DSE	1 [2.5V LVTTL DSE	
1.8V LVTTL DSE	1 [1.8V LVTTL DSE	
LVEPECL DSE	1 [LVEPECL DSE	
eHSTL DSE	1 [eHSTL DSE	
HSTL DSE	1 [HSTL DSE	
2.5V LVTTL DIF	1 [2.5V LVTTL DIF	
1.8V LVTTL DIF	1 [1.8V LVTTL DIF	
LVEPECL DIF	1 [LVEPECL DIF	
eHSTL DIF	1 [eHSTL DIF	
HSTL DIF	1 [HSTL DIF	
2.5V LVTTL SE	1.8VLVTTL	2.5V LVTTL SE	HSTL
1.8V LVTTL SE	1 [1.8V LVTTL SE	
2.5V LVTTL DSE	1 [2.5V LVTTL DSE	
1.8V LVTTL DSE	1 [1.8V LVTTL DSE	
LVEPECL DSE	1 [LVEPECL DSE	
eHSTL DSE	1 [eHSTL DSE	
HSTL DSE	1 [HSTL DSE	
2.5V LVTTL DIF	1 [2.5V LVTTL DIF	
1.8V LVTTL DIF	1 [1.8V LVTTL DIF	
LVEPECL DIF	1 [LVEPECL DIF	
eHSTL DIF	1 [eHSTL DIF	
HSTL DIF	1 [HSTL DIF	

NOTE:

1. The INPUT/OUTPUT SELECTION Table describes the total possible combinations of input and output interfaces. Single-Ended (SE) inputs in a single-ended mode require the Ā/VREF pin to be connected to GND. Differential Single-Ended (DSE) is for single-ended operation in differential mode, requiring a VREF. Differential (DIF) inputs are used only in differential mode.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	-	Min.	Max	Unit	
Vihh	Input HIGH Voltage Level ⁽¹⁾	3-Level Inputs Only		Vdd - 0.4	—	V
VIMM	Input MID Voltage Level ⁽¹⁾	3-Level Inputs Only		Vdd/2 - 0.2	VDD/2 + 0.2	V
Vill	Input LOW Voltage Level ⁽¹⁾	3-Level Inputs Only		_	0.4	V
		Vin = Vdd	HIGH Level	—	200	
I 3	3-Level Input DC Current (RxS, TxS)	$V_{IN} = V_{DD}/2$	MID Level	-50	+50	μA
		Vin = GND	LOW Level	-200	_	

NOTE:

1. These inputs are normally wired to Vod, GND, or left floating. Internal temination resistors bias unconnected inputs to Vod/2.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR HSTL⁽¹⁾

Parameter	Test Conditions		Min.	Тур. ⁽⁷⁾	Max	Unit
cteristics	-					
Input HIGH Current ⁽⁹⁾	VDD = 2.6V	VI = VDDQ/GND	—	—	±5	μΑ
Input LOW Current ⁽⁹⁾	VDD = 2.6V	VI = GND/VDDQ	—	—	±5	
Clamp Diode Voltage	VDD = 2.4V, IIN =	-18mA	—	- 0.7	- 1.2	V
DC Input Voltage			- 0.3		+3.6	V
DC Differential Voltage ^(2,8)			0.2		—	V
DC Common Mode Input Voltage ^(3,8)			680	750	900	mV
DC Input HIGH ^(4,5,8)			Vref + 100		—	mV
DC Input LOW ^(4,6,8)			—		Vref - 100	mV
Single-Ended Reference Voltage ^(4,8)			_	750	—	mV
	teristics Input HIGH Current ⁽⁹⁾ Input LOW Current ⁽⁹⁾ Clamp Diode Voltage DC Input Voltage DC Differential Voltage ^(2,8) DC Common Mode Input Voltage ^(3,8) DC Input HIGH ^(4,5,8) DC Input LOW ^(4,6,8)	teristicsInput HIGH Current ⁽⁹⁾ $V_{DD} = 2.6V$ Input LOW Current ⁽⁹⁾ $V_{DD} = 2.6V$ Clamp Diode Voltage $V_{DD} = 2.4V$, $I_{IN} =$ DC Input VoltageDC Differential Voltage ^(2,8) DC Common Mode Input Voltage ^(3,8) DCDC Input HIGH ^(4,5,8) DC Input LOW ^(4,6,8)	teristics Input HIGH Current ⁽⁹⁾ VDD = 2.6V VI = VDDO/GND Input LOW Current ⁽⁹⁾ VDD = 2.6V VI = GND/VDDO Clamp Diode Voltage VDD = 2.4V, IIN = -18mA DC Input Voltage DC Differential Voltage ^(2,8) DC Common Mode Input Voltage ^(3,8) DC Input HIGH ^(4,5,8) DC Input LOW ^(4,6,8) DC Input LOW ^(4,6,8)	teristicsInput HIGH Current ⁽⁹⁾ VDD = 2.6VVI = VDDO/GND—Input LOW Current ⁽⁹⁾ VDD = 2.6VVI = GND/VDDO—Clamp Diode VoltageVDD = 2.4V, IIN = -18mA—DC Input Voltage0.2-0.3DC Differential Voltage ^(2,8) 0.2DC Common Mode Input Voltage ^(3,8) 680DC Input HIGH ^(4,5,8) VREF + 100DC Input LOW ^(4,6,8) —	Input HIGH Current ⁽⁹⁾ VDD = 2.6V VI = VDDO/GND — — Input LOW Current ⁽⁹⁾ VDD = 2.6V VI = GND/VDDO — …	Input HIGH Current ⁽⁹⁾ VDD = 2.6V VI = VDD0/GND ±5 Input LOW Current ⁽⁹⁾ VDD = 2.6V VI = GND/VDDQ ±5 Clamp Diode Voltage VDD = 2.4V, IIN = -18mA 0.7 -1.2 DC Input Voltage VDD = 2.4V, IIN = -18mA -0.7 -1.2 DC Input Voltage 0.2 DC Differential Voltage ^(2.8) 0.2 - DC Common Mode Input Voltage ^(3.8) 680 750 900 DC Input HIGH ^(4.5.8) VREF + 100 - DC Input LOW ^(4.6.8) VREF - 100 -

Output Characteristics

Vон	Output HIGH Voltage	І он = -8mA	Vddq - 0.4	—	V
		Іон = -100μА	Vddq - 0.1	_	V
Vol	Output LOW Voltage	Iol = 8mA	_	0.4	V
		Iol = 100µA	—	0.1	V

NOTES:

1. See RECOMMENDED OPERATING RANGE table.

2. VDIF specifies the minimum input differential voltage (VTR - VCP) required for switching where VTR is the "true" input level and VCP is the "complement" input level. Differential mode only. The DC differential voltage must be maintained to guarantee retaining the existing HIGH or LOW input. The AC differential voltage must be achieved to guarantee switching to a new state.

3. VCM specifies the maximum allowable range of (VTR + VCP) /2. Differential mode only.

4. For single-ended operation, in differential mode, A/VREF is tied to the DC voltage VREF.

5. Voltage required to maintain a logic HIGH, single-ended operation in differential mode.

6. Voltage required to maintain a logic LOW, single-ended operation in differential mode.

7. Typical values are at VDD = 2.5V, VDDQ = 1.5V, +25°C ambient.

8. The reference clock input is capable of HSTL, eHSTL, LVEPECL, 1.8V or 2.5V LVTTL operation independent of the device output. The correct input interface table should be referenced.

9. For differential mode (RxS = LOW), A and \overline{A}/V_{REF} must be at the opposite rail.

POWER SUPPLY CHARACTERISTICS FOR HSTL OUTPUTS⁽¹⁾

Symbol	Parameter	Test Conditions ⁽²⁾	Тур.	Max	Unit
Iddq	Quiescent Vod Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	20	30	mA
		Outputs enabled, All outputs unloaded			
Ισροα	Quiescent Voda Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	0.1	0.3	mA
		Outputs enabled, All outputs unloaded			
lddd	Dynamic Vod Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	20	30	μA/MHz
	Current per Output				
Idddq	Dynamic Vodo Power Supply	$V_{DD} = Max., V_{DDQ} = Max., C_L = 0pF$	30	50	μA/MHz
	Current per Output				
Ітот	Total Power Vod Supply Current	VDDQ = 1.5V, FREFERENCE CLOCK = 100MHz, CL = 15pF	20	40	mA
		VDDQ = $1.5V$, Freference clock = $250MHz$, CL = $15pF$	35	50	
Ιτοτο	Total Power Vodo Supply Current	VDDQ = 1.5V, FREFERENCE CLOCK = 100MHz, CL = 15pF	35	70	mA
		VDDQ = 1.5V, FREFERENCE CLOCK = 250MHz, CL = 15pF	50	100	†

NOTES:

1. These power consumption characteristics are for all the valid input interfaces and cover the worst case input and output interface combinations.

2. The termination resistors are excluded from these measurements.

3. If the differential input interface is used, the true input is held LOW and the complementary input is held HIGH.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR HSTL

Symbol	Parameter	Value	Units
Vdif	Input Signal Swing ⁽¹⁾	1	V
Vx	Differential Input Signal Crossing Point ⁽²⁾	750	mV
Vthi	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
tr, tr	Input Signal Edge Rate ⁽⁴⁾	1	V/ns

NOTES:

1. The 1V peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the VDIF (AC) specification under actual use conditions.

2. A 750mV crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the Vx specification under actual use conditions.

3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.

4. The input signal edge rate of 1V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR eHSTL⁽¹⁾

Symbol	Parameter	Test Conditions		Min.	Тур. ⁽⁷⁾	Мах	Unit
Input Chara	cteristics						
Ін	Input HIGH Current ⁽⁹⁾	VDD = 2.6V	$V_I = V_{DDQ}/GND$	—	—	±5	μA
١L	Input LOW Current ⁽⁹⁾	VDD = 2.6V	VI = GND/VDDQ	—	—	±5	
Vik	Clamp Diode Voltage	Vdd = 2.4V, Iin = -18mA		—	- 0.7	- 1.2	V
Vin	DC Input Voltage			- 0.3		+3.6	V
Vdif	DC Differential Voltage ^(2,8)			0.2		-	V
Vсм	DC Common Mode Input Voltage ^(3,8)			800	900	1000	mV
Vih	DC Input HIGH ^(4,5,8)			Vref + 100		_	mV
Vil	DC Input LOW ^(4,6,8)			—		Vref - 100	mV
Vref	Single-Ended Reference Voltage ^(4,8)			-	900	—	mV

Output Characteristics

Vон	Output HIGH Voltage	Iон = -8mA	Vddq - 0.4	_	V
		Іон = -100μА	Vddq - 0.1	-	V
Vol	Output LOW Voltage	Iol = 8mA	_	0.4	V
		Iol = 100μA	—	0.1	V

NOTES:

1. See RECOMMENDED OPERATING RANGE table.

2. VDIF specifies the minimum input differential voltage (VTR - VCP) required for switching where VTR is the "true" input level and VCP is the "complement" input level. Differential mode only. The DC differential voltage must be maintained to guarantee retaining the existing HIGH or LOW input. The AC differential voltage must be achieved to guarantee switching to a new state.

3. VCM specifies the maximum allowable range of (VTR + VCP) /2. Differential mode only.

4. For single-ended operation, in a differential mode, AVREF is tied to the DC voltage VREF.

5. Voltage required to maintain a logic HIGH, single-ended operation in differential mode.

6. Voltage required to maintain a logic LOW, single-ended operation in differential mode.

7. Typical values are at VDD = 2.5V, VDDQ = 1.8V, +25°C ambient.

8. The reference clock input is capable of HSTL, eHSTL, LVEPECL, 1.8V or 2.5V LVTTL operation independent of the device output. The correct input interface table should be referenced.

9. For differential mode (RxS = LOW), A and \overline{A}/V_{REF} must be at the opposite rail.

POWER SUPPLY CHARACTERISTICS FOR eHSTL OUTPUTS⁽¹⁾

Symbol	Parameter	Test Conditions ⁽²⁾	Тур.	Max	Unit
DDQ	Quiescent Vod Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	20	30	mA
		Outputs enabled, All outputs unloaded			
DDQQ	Quiescent Voda Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	0.1	0.3	mA
		Outputs enabled, All outputs unloaded			
Iddd	Dynamic Vod Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	20	30	μA/MHz
	Current per Output				
DDDQ	Dynamic Vodo Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	40	60	μA/MHz
	Current per Output				
Ітот	Total Power Vod Supply Current	VDDQ = 1.8V, FREFERENCE CLOCK = 100MHz, CL = 15pF	20	40	mA
		VDDQ = 1.8V, FREFERENCE CLOCK = 250MHz, CL = 15pF	35	50	
Ιτοτο	Total Power VDDQ Supply Current	VDDQ = 1.8V, FREFERENCE CLOCK = 100MHz, CL = 15pF	40	80	mA
		VDDQ = 1.8V, FREFERENCE CLOCK = 250MHZ, CL = 15pF	80	160	1

NOTES:

1. These power consumption characteristics are for all the valid input interfaces and cover the worst case input and output interface combinations.

2. The termination resistors are excluded from these measurements.

3. If the differential input interface is used, the true input is held LOW and the complementary input is held HIGH.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR eHSTL

Symbol	Parameter	Value	Units
Vdif	Input Signal Swing ⁽¹⁾	1	V
Vx	Differential Input Signal Crossing Point ⁽²⁾	900	mV
Vthi	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
tr, tr	Input Signal Edge Rate ⁽⁴⁾	1	V/ns

NOTES:

1. The 1V peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the VDIF (AC) specification under actual use conditions.

2. A 900mV crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the Vx specification under actual use conditions.

3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.

4. The input signal edge rate of 1V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR LVEPECL⁽¹⁾

Symbol	Parameter	Test Conditions		Min.	Typ. ⁽²⁾	Max	Unit	
Input Characteristics								
Ін	Input HIGH Current ⁽⁶⁾	$V_{DD} = 2.6V$	$V_I = V_{DDQ}/GND$	_	-	±5	μA	
١L	Input LOW Current ⁽⁶⁾	VDD = 2.6V	VI = GND/VDDQ	—	-	±5		
Vik	Clamp Diode Voltage	VDD = 2.4V, IIN =	-18mA	—	- 0.7	- 1.2	V	
Vin	DC Input Voltage			- 0.3	-	3.6	V	
Vсм	DC Common Mode Input Voltage ^(3,5)			915	1082	1248	mV	
Vref	Single-Ended Reference Voltage ^(4,5)			—	1082	—	mV	
Vih	DC Input HIGH			1275	_	1620	mV	
Vil	DC Input LOW			555	—	875	mV	

NOTES:

1. See RECOMMENDED OPERATING RANGE table.

2. Typical values are at VDD = 2.5V, $+25^{\circ}C$ ambient.

- 3. VCM specifies the maximum allowable range of (VTR + VCP) /2. Differential mode only.
- 4. For single-ended operation while in differential mode, A/VREF is tied to the DC voltage VREF.
- 5. The reference clock input is capable of HSTL, eHSTL, LVEPECL, 1.8V or 2.5V LVTTL operation independent of the device output. The correct input interface table should be referenced.
- 6. For differential mode (RxS = LOW), A and \overline{A}/V_{REF} must be at the opposite rail.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR LVEPECL

Symbol	Parameter	Value	Units
Vdif	Input Signal Swing ⁽¹⁾	732	mV
Vx	Differential Input Signal Crossing Point ⁽²⁾	1082	mV
Vthi	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
tr, tr	Input Signal Edge Rate ⁽⁴⁾	1	V/ns

NOTES:

1. The 732mV peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the VDIF (AC) specification under actual use conditions.

2. A 1082mV crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the Vx specification under actual use conditions.

3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.

4. The input signal edge rate of 1V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR 2.5V $\rm LVTTL^{(1)}$

Symbol	Parameter	Test Co	onditions	Min.	Тур. ⁽⁸⁾	Max	Unit
Input Chara	cteristics						
Іін	Input HIGH Current ⁽¹⁰⁾	$V_{DD} = 2.6V$	VI = VDDQ/GND	—	_	±5	μA
١L	Input LOW Current ⁽¹⁰⁾	VDD = 2.6V	VI = GND/VDDQ	—	_	±5	
Vik	Clamp Diode Voltage	VDD = 2.4V, IIN =	-18mA	—	- 0.7	- 1.2	V
Vin	DC Input Voltage			- 0.3		+3.6	V
Single-End	ed Inputs ⁽²⁾					-	
Vih	DC Input HIGH			1.7		—	V
Vil	DC Input LOW			—		0.7	V
Differential	Inputs						
Vdif	DC Differential Voltage ^(3,9)			0.2		_	V
Vсм	DC Common Mode Input Voltage ^(4,9)			1150	1250	1350	mV
Vih	DC Input HIGH ^(5,6,9)			Vref + 100		_	mV
Vil	DC Input LOW ^(5,7,9)			—		Vref - 100	mV
Vref	Single-Ended Reference Voltage ^(5,9)			—	1250	_	mV
Output Cha	racteristics	·					
Vон	Output HIGH Voltage	Іон = -12mA		VDDQ - 0.4		_	V

Vон	Output HIGH Voltage	Іон = -12mA	Vddq - 0.4	—	V
		Іон = -100μА	Vddq - 0.1	—	V
Vol	Output LOW Voltage	Iol = 12mA	—	0.4	V
		Iol = 100µA	—	0.1	V

NOTES:

1. See RECOMMENDED OPERATING RANGE table.

2. For 2.5V LVTTL single-ended operation, the RxS pin is tied HIGH and A/VREF is tied to GND.

3. VDIF specifies the minimum input differential voltage (VTR - VCP) required for switching where VTR is the "true" input level and VCP is the "complement" input level. Differential mode only. The DC differential voltage must be maintained to guarantee retaining the existing HIGH or LOW input. The AC differential voltage must be achieved to guarantee switching to a new state.

- 4. VCM specifies the maximum allowable range of (VTR + VCP) /2. Differential mode only.
- 5. For single-ended operation, in differential mode, \overline{A}/V_{REF} is tied to the DC voltage V_{REF}.
- 6. Voltage required to maintain a logic HIGH, single-ended operation in differential mode.
- 7. Voltage required to maintain a logic LOW, single-ended operation in differential mode.
- 8. Typical values are at VDD = 2.5V, VDDQ = VDD, +25°C ambient.
- 9. The reference clock input is capable of HSTL, eHSTL, LVEPECL, 1.8V or 2.5V LVTTL operation independent of the device output. The correct input interface table should be referenced.
- 10. For differential mode (RxS = LOW), A and \overline{A}/V_{REF} must be at the opposite rail.

POWER SUPPLY CHARACTERISTICS FOR 2.5V LVTTL OUTPUTS⁽¹⁾

Symbol	Parameter	Test Conditions ⁽²⁾	Тур.	Max	Unit
DDQ	Quiescent Vod Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	20	30	mA
		Outputs enabled, All outputs unloaded			
DDQQ	Quiescent VDDQ Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	0.1	0.3	mA
		Outputs enabled, All outputs unloaded			
Iddd	Dynamic Vod Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	25	40	μA/MHz
	Current per Output				
DDDQ	Dynamic Vodo Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	40	70	μA/MHz
	Current per Output				
Ітот	Total Power Vod Supply Current	VDDQ = 2.5V, FREFERENCE CLOCK = 100MHz, CL = 15pF	25	40	mA
		VDDQ = 2.5V, FREFERENCE CLOCK = 200MHz, CL = 15pF	40	70	
Ιτοτο	Total Power VDDQ Supply Current	VDDQ = 2.5V, FREFERENCE CLOCK = 100MHz, CL = 15pF	40	80	mA
		VDDQ = 2.5V, FREFERENCE CLOCK = 200MHz, CL = 15pF	100	200	1

NOTES:

1. These power consumption characteristics are for all the valid input interfaces and cover the worst case input and output interface combinations.

2. The termination resistors are excluded from these measurements.

3. If the differential input interface is used, the true input is held LOW and the complementary input is held HIGH.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR 2.5V LVTTL

Symbol	Parameter	Value	Units
Vdif	Input Signal Swing ⁽¹⁾	Vdd	V
Vx	Differential Input Signal Crossing Point ⁽²⁾	Vdd/2	V
Vтні	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
tr, tr	Input Signal Edge Rate ⁽⁴⁾	2.5	V/ns

NOTES:

1. A nominal 2.5V peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the VDIF (AC) specification under actual use conditions.

2. A nominal 1.25V crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the Vx specification under actual use conditions.

3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.

4. The input signal edge rate of 2.5V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

SINGLE-ENDED INPUT AC TEST CONDITIONS FOR 2.5V LVTTL

Symbol	Parameter	Value	Units
Vih	Input HIGH Voltage	Vdd	V
VIL	InputLOWVoltage	0	V
Vthi	Input Timing Measurement Reference Level ⁽¹⁾	Vdd/2	V
tr, tr	Input Signal Edge Rate ⁽²⁾	2	V/ns

NOTES:

1. A nominal 1.25V timing measurement reference level is specified to allow constant, repeatable results in an automatic test equipment (ATE) environment.

2. The input signal edge rate of 2V/ns or greater is to be maintained in the 10% to 90% range of the input waveform.

0.1

V

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR 1.8V LVTTL⁽¹⁾

Symbol	Parameter	Test Co	onditions	Min.	Тур. ⁽⁸⁾	Max	Unit
Input Char	acteristics	•		· · ·		•	
Іін	Input HIGH Current ⁽¹²⁾	VDD = 2.6V	VI = VDDQ/GND	-	—	±5	μΑ
li	Input LOW Current ⁽¹²⁾	VDD = 2.6V	VI = GND/VDDQ	-	_	±5	
Vik	Clamp Diode Voltage	VDD = 2.4V, IIN =	-18mA	-	- 0.7	- 1.2	V
Vin	DC Input Voltage			- 0.3		VDDQ + 0.3	V
Single-End	ded Inputs ⁽²⁾	•		• •		• • •	
Vih	DC Input HIGH			1.073(10)			V
Vil	DC Input LOW			—		0.683(11)	V
Differentia	Inputs	•					
Vdif	DC Differential Voltage ^(3,9)			0.2		-	V
Vсм	DC Common Mode Input Voltage ^(4,9)			825	900	975	mV
Vih	DC Input HIGH ^(5,6,9)			Vref + 100			mV
VIL	DC Input LOW ^(5,7,9)			-		Vref - 100	mV
VREF	Single-Ended Reference Voltage ^(5,9)				900		mV
Output Cha	aracteristics					• • •	
Vон	Output HIGH Voltage	І он = -6mA		VDDQ - 0.4			V
		Іон = -100μА		Vddq - 0.1		_	V
Vol	Output LOW Voltage	IoL = 6mA		_		0.4	V

NOTES:

1. See RECOMMENDED OPERATING RANGE table.

 $IOL = 100 \mu A$

3. VDIF specifies the minimum input differential voltage (VTR - VCP) required for switching where VTR is the "true" input level and VCP is the "complement" input level. Differential mode only. The DC differential voltage must be maintained to guarantee retaining the existing HIGH or LOW input. The AC differential voltage must be achieved to guarantee switching to a new state.

4. VCM specifies the maximum allowable range of (VTR + VCP) /2. Differential mode only.

- 5. For single-ended operation in differential mode, $\overline{A}V_{REF}$ is tied to the DC voltage VREF. The input is guaranteed to toggle within ±200mV of VREF when VREF is constrained within +600mV and VDDI-600mV, where VDDI is the nominal 1.8V power supply of the device driving the A input. To guarantee switching in voltage range specified in the JEDEC 1.8V LVTTL interface specification, VREF must be maintained at 900mV with appropriate tolerances.
- 6. Voltage required to maintain a logic HIGH, single-ended operation in differential mode.
- 7. Voltage required to maintain a logic LOW, single-ended operation in differential mode.
- 8. Typical values are at VDD = 2.5V, VDDQ = 1.8V, +25°C ambient.
- 9. The reference clock input is capable of HSTL, eHSTL, LVEPECL, 1.8V or 2.5V LVTTL operation independent of the device output. The correct input interface table should be referenced.
- 10. This value is the worst case minimum VIII over the specification range of the 1.8V power supply. The 1.8V LVTTL specification is $V_{IH} = 0.65 \cdot V_{DD}$ where V_{DD} is $1.8V \pm 0.15V$. However, the LVTTL translator is supplied by a 2.5V nominal supply on this part. To ensure compliance with the specification, the translator was designed to accept the calculated worst case value ($V_{IH} = 0.65 \cdot [1.8 - 0.15V]$) rather than reference against a nominal 1.8V supply.
- 11. This value is the worst case maximum V_{IL} over the specification range of the 1.8V power supply. The 1.8V LVTTL specification is $V_{\text{IL}} = 0.35 \cdot V_{\text{DD}}$ where V_{DD} is 1.8V \pm 0.15V. However, the LVTTL translator is supplied by a 2.5V nominal supply on this part. To ensure compliance with the specification, the translator was designed to accept the calculated worst case value ($V_{\text{IL}} = 0.35 \cdot [1.8 + 0.15V]$) rather than reference against a nominal 1.8V supply.
- 12. For differential mode (RxS = LOW), A and AVREF must be at the opposite rail.

^{2.} For 1.8V LVTTL single-ended operation, the RxS pin is allowed to float or tied to VDD/2 and AVREF is tied to GND.

POWER SUPPLY CHARACTERISTICS FOR 1.8V LVTTL OUTPUTS⁽¹⁾

Symbol	Parameter	Test Conditions ⁽²⁾	Тур.	Max	Unit
Iddq	Quiescent Vod Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	20	30	mA
		Outputs enabled, All outputs unloaded			
IDDQQ	Quiescent VDDQ Power Supply Current	VDDQ = Max., Reference Clock = LOW ⁽³⁾	0.1	0.3	mA
		Outputs enabled, All outputs unloaded			
Iddd	Dynamic Vod Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	20	40	μA/MHz
	Current per Output				
DDDQ	Dynamic Vodo Power Supply	VDD = Max., VDDQ = Max., CL = 0pF	55	80	μA/MHz
	Current per Output				
Ітот	Total Power Vod Supply Current	VDDQ = 1.8V, FREFERENCE CLOCK = 100MHz, CL = 15pF	25	40	mA
		VDDQ = 1.8V, FREFERENCE CLOCK = 200MHz, CL = 15pF	40	60	
Ιτοτο	Total Power VDDQ Supply Current	VDDQ = 1.8V, FREFERENCE CLOCK = 100MHz, CL = 15pF	55	110	mA
		VDDQ = 1.8V, FREFERENCE CLOCK = 200MHZ, CL = 15pF	130	260	1

NOTES:

1. These power consumption characteristics are for all the valid input interfaces and cover the worst case input and output interface combinations.

2. The termination resistors are excluded from these measurements.

3. If the differential input interface is used, the true input is held LOW and the complementary input is held HIGH.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR 1.8V LVTTL

Symbol	Parameter	Value	Units
Vdif	Input Signal Swing ⁽¹⁾	Vddi	V
Vx	Differential Input Signal Crossing Point ⁽²⁾	Vddi/2	mV
Vthi	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
tr, tr	Input Signal Edge Rate ⁽⁴⁾	1.8	V/ns

NOTES:

1. Vbbl is the nominal 1.8V supply (1.8V ± 0.15V) of the part or source driving the input. A nominal 1.8V peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the VDIF (AC) specification under actual use conditions.

2. A nominal 900mV crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. Compliant devices must meet the Vx specification under actual use conditions.

3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.

4. The input signal edge rate of 1.8V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

SINGLE-ENDED INPUT AC TEST CONDITIONS FOR 1.8V LVTTL

Symbol	Parameter	Value	Units
Vih	Input HIGH Voltage ⁽¹⁾	Vddi	V
Vil	InputLOWVoltage	0	V
Vthi	Input Timing Measurement Reference Level ⁽²⁾	Vddi/2	mV
tr, tr	Input Signal Edge Rate ⁽³⁾	2	V/ns

NOTES:

1. VDDI is the nominal 1.8V supply (1.8V \pm 0.15V) of the part or source driving the input.

2. A nominal 900mV timing measurement reference level is specified to allow constant, repeatable results in an automatic test equipment (ATE) environment.

3. The input signal edge rate of 2V/ns or greater is to be maintained in the 10% to 90% range of the input waveform.

AC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE⁽⁷⁾

Symbol	Parameter	Parameter			Max	Unit
Skew Parameters	·	•			•	
tsк(o)	Same Device Output Pin-to-Pin Skew ⁽¹⁾	Single-Ended and Differential Modes	_	_	25	ps
		Single-Ended in Differential Mode (DSE)	_	25	_	
tsк(р) ⁽²⁾	Pulse Skew ⁽³⁾	Single-Ended and Differential Modes	_	_	300	ps
		Single-Ended in Differential Mode (DSE)	_	300	_	
tsk(p) ⁽⁴⁾	Pulse Skew ⁽³⁾	Single-Ended and Differential Modes	_	_	350	ps
		Single-Ended in Differential Mode (DSE)	_	350	_	
dT ⁽⁵⁾	Duty Cycle	Duty Cycle		_	60	%
tsk(pp)	Part-to-Part Skew ⁽⁶⁾	Single-Ended and Differential Modes	_	_	300	ps
		Single-Ended in Differential Mode (DSE)	_	300	_	
Propagation Delay	y					
t PLH	Propagation Delay A to Qn		_	_	2.5	ns
t PHL						
tR	Output Rise Time (20% to 80%) 2.5V/1.8V LVTTL Outputs		350	_	1050	DS

u ne						
tr	Output Rise Time (20% to 80%)	2.5V / 1.8V LVTTL Outputs	350	_	1050	ps
		HSTL / eHSTL Outputs	350	-	1350	
tr	Output Fall Time (20% to 80%)	2.5V / 1.8V LVTTL Outputs	350	-	1050	ps
		HSTL / eHSTL Outputs	350	-	1350]
fo	o Frequency Range (HSTL/eHSTL outputs)		_	—	250	MHz
	Frequency Range (2.5V/1.8V LVTTL outputs)		_	—	200	
Output Gate Enab	le/Disable Delay					
toor	Output Cata Epoblata Op				2 5	nc

NOTEO						
tpgd	Output Gate Enable to Qn Driven to GL Designated Level	-		3	ns	
T PGE	Output Gate Enable to Qn	—	_	3.5	ns	

NOTES:

1. Skew measured between all outputs under identical input and output interfaces, transitions, and load conditions on any one device.

2. For 1.8V LVTTL and eHSTL outputs only.

3. Skew measured is difference between propagation times tPLH and tPHL of any output under identical input and output interfaces, transitions, and load conditions on any one device.

4. For 2.5V LVTTL outputs only.

5. For HSTL outputs only.

6. Skew measured is the magnitude of the difference in propagation times between any outputs of two devices, given identical transitions and load conditions at identical VDD/VDDQ levels and temperature.

7. Guaranteed by design.

AC DIFFERENTIAL INPUT SPECIFICATIONS⁽¹⁾

Symbol	Parameter	Min.	Тур.	Max	Unit
tw	Reference Clock Pulse Width HIGH or LOW (HSTL/eHSTL outputs) ⁽²⁾	1.73	—	_	ns
	Reference Clock Pulse Width HIGH or LOW (2.5V / 1.8V LVTTL outputs) ⁽²⁾	2.17	-	_	
HSTL/eHSTL/1.8	V LVTTL/2.5V LVTTL				
Vdif	AC Differential Voltage ⁽³⁾	400	—	_	mV
Vih	AC Input HIGH ^(4,5)	Vx + 200	—	_	mV
Vil	AC Input LOW ^(4,6)	_	—	Vx - 200	mV
LVEPECL			•		
Vdif	AC Differential Voltage ⁽³⁾	400	—	_	mV
Vih	AC Input HIGH ⁽⁴⁾	1275	_	_	mV
Vil	AC Input LOW ⁽⁴⁾	_	_	875	mV
NOTES:		•		-	•

1. For differential input mode, RxS is tied to GND.

2. Both differential input signals should not be driven to the same level simultaneously. The input will not change state until the inputs have crossed and the voltage range defined by VDIF has been met or exceeded.

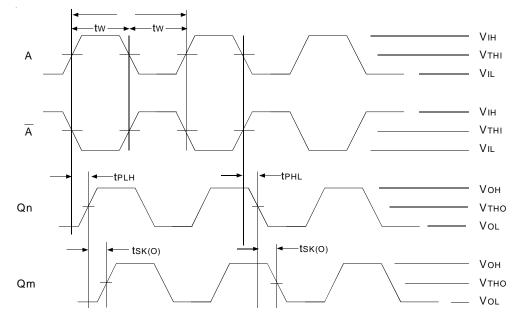
3. Differential mode only. VDIF specifies the minimum input voltage (VTR - VCP) required for switching where VTR is the "true" input level and VCP is the "complement" input level. The AC differential voltage must be achieved to guarantee switching to a new state.

4. For single-ended operation, A/VREF is tied to DC voltage (VREF). Refer to each input interface's DC specification for the correct VREF range.

5. Voltage required to switch to a logic HIGH, single-ended operation only.

6. Voltage required to switch to a logic LOW, single-ended operation only.

AC TIMING WAVEFORMS

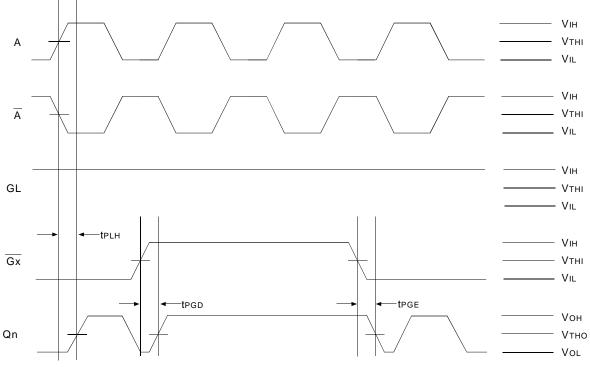


Propagation and Skew Waveforms

NOTES:

- 1. TPHL and TPLH signals are measured from the input passing through VTHI or input pair crossing to Qn passing through VTHO.
- 2. Pulse Skew is calculated using the following expression:
 - tsk(p) = | tphl tplh |

where tPHL and tPLH are measured on the controlled edges of any one output from rising and falling edges of a single pulse. Please note that the tPHL and tPLH shown are not valid measurements for this calculation because they are not taken from the same pulse.

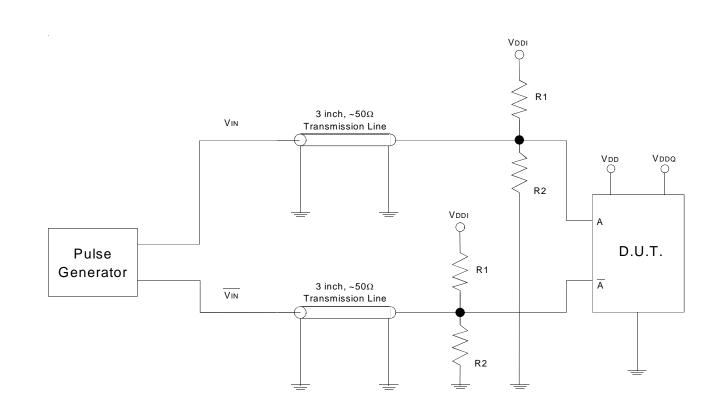


Gate Disable/Enable Showing Runt Pulse Generation

NOTE:

As shown, it is possible to generate runt pulses on gate disable and enable of the outputs. It is the user's responsibility to time their Gx signals to avoid this problem.

TEST CIRCUITS AND CONDITIONS



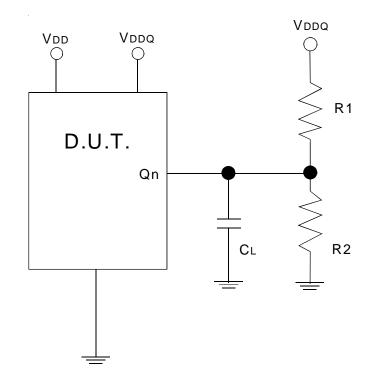
Test Circuit for Differential Input⁽¹⁾

Symbol	$V_{DD} = 2.5V \pm 0.1V$	Unit
R1	100	Ω
R2	100	Ω
Vddi	Vсм*2	V
Vтні	HSTL: Crossing of A and \overline{A} eHSTL: Crossing of A and \overline{A} LVEPECL: Crossing of A and \overline{A} 1.8V LVTTL: VDD/2 2.5V LVTTL: VDD/2	V

DIFFERENTIAL INPUT TEST CONDITIONS

NOTE:

1. This input configuration is used for all input interfaces. For single-ended testing, the $\overline{V_{IN}}$ input is tied to GND. For testing single-ended in differential input mode, the $\overline{V_{IN}}$ is left floating.



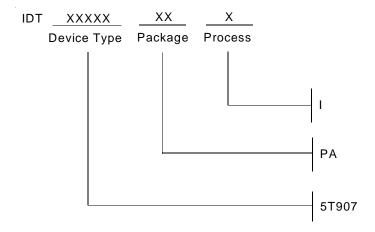
Test Circuit for SDR Outputs

SDR OUTPUT TEST CONDITIONS

Symbol	$V_{DD} = 2.5V \pm 0.1V$	Unit
	VDDQ = Interface Specified	
CL	15	pF
R1	100	Ω
R2	100	Ω
Vтно	Vdda / 2	V

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